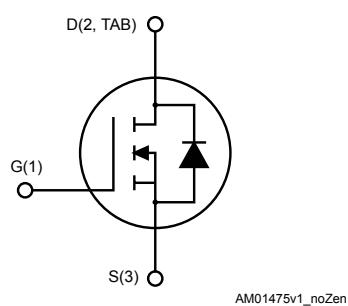
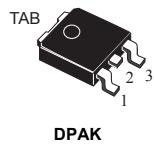


N-channel 60 V, 70 mΩ typ., 12 A, StripFET™ II Power MOSFET in a DPAK package

Features



Order code	V _{DS}	R _{D(on)} max.	I _D
STD12NF06LT4	60 V	90 mΩ	12 A

- Exceptional dv/dt capability
- 100% avalanche tested
- Low gate charge

Applications

- Switching applications

Description

This Power MOSFET series has been developed using STMicroelectronics' unique STripFET™ process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

Product status link	
STD12NF06LT4	
Product summary	
Order code	
Order code	STD12NF06LT4
Marking	D12NF06L
Package	DPAK
Packing	Tape and reel

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	60	V
V_{GS}	Gate-source voltage	± 16	V
I_D	Drain current (continuous) at $T_{case} = 25^\circ C$	12	A
	Drain current (continuous) at $T_{case} = 100^\circ C$	8.5	
$I_{DM}^{(1)}$	Drain current (pulsed)	48	A
P_{TOT}	Total dissipation at $T_{case} = 25^\circ C$	30	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	15	V/ns
$E_{AS}^{(3)}$	Single pulse avalanche energy	100	mJ
T_{stg}	Storage temperature range	-55 to 175	$^\circ C$
T_J	Operating junction temperature range		

1. Pulse width is limited by safe operating area.
2. $I_{SD} \leq 12 A$, $di/dt \leq 200 A/\mu s$, $V_{DS} \leq 40 V$, $T_J \leq T_{JMAX}$
3. Starting $T_j = 25^\circ C$, $I_D = 6 A$, $V_{DD} = 30 V$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	5	$^\circ C/W$
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb	50	

1. When mounted on a 1-inch² FR-4, 2 Oz copper board.

2 Electrical characteristics

($T_{case} = 25^\circ\text{C}$ unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 60 \text{ V}$			1	μA
		$V_{GS} = 0 \text{ V}, V_{DS} = 60 \text{ V}, T_{case} = 125^\circ\text{C}^{(1)}$			10	
I_{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1		2	V
$R_{DSS(on)}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$		70	90	$\text{m}\Omega$
		$V_{GS} = 5 \text{ V}, I_D = 6 \text{ A}$		80	100	

1. Defined by design, not subject to production test.

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	350		pF
C_{oss}	Output capacitance		-	75		
C_{rss}	Reverse transfer capacitance		-	30		
Q_g	Total gate charge	$V_{DD} = 48 \text{ V}, I_D = 12 \text{ A}, V_{GS} = 0 \text{ to } 5 \text{ V}$ (see Figure 13. Test circuit for gate charge behavior)	-	7.5	10	nC
Q_{gs}	Gate-source charge		-	2.5		
Q_{gd}	Gate-drain charge		-	3.0		

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 30 \text{ V}, I_D = 6 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 4.5 \text{ V}$ (see Figure 12. Test circuit for resistive load switching times and Figure 17. Switching time waveform)	-	10	-	ns
t_r	Rise time		-	35	-	
$t_{d(off)}$	Turn-off delay time		-	20	-	
t_f	Fall time		-	13	-	

Table 6. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		12	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		48	A

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0 \text{ V}$, $I_{SD} = 12 \text{ A}$	-		1.5	V
t_{rr}	Reverse recovery time	$I_{SD} = 12 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$,	-	50		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 16 \text{ V}$, $T_J = 150 \text{ }^\circ\text{C}$ (see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	65		nC
I_{RRM}	Reverse recovery current		-	2.5		A

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

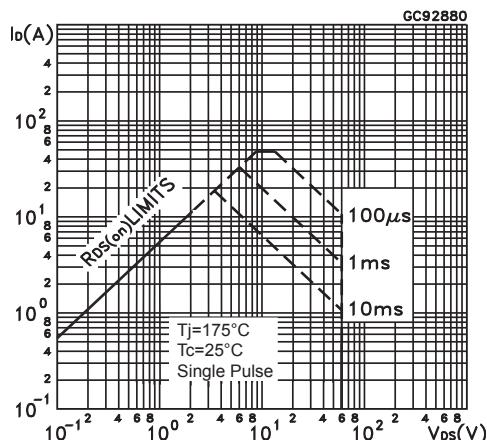


Figure 2. Thermal impedance

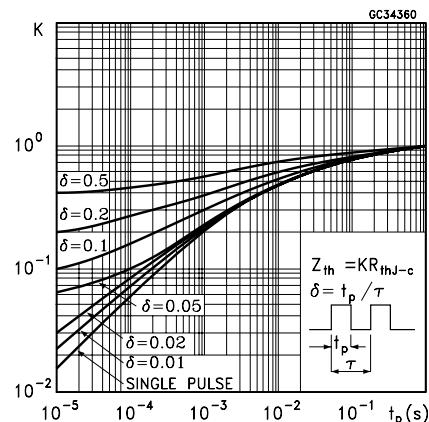


Figure 3. Output characteristics

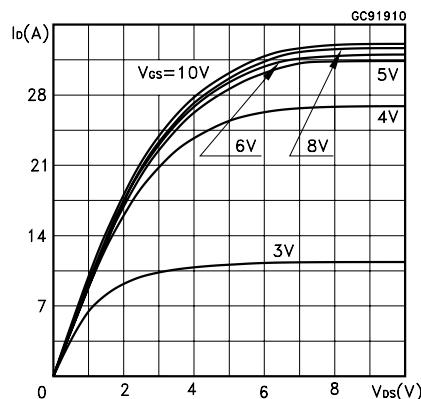


Figure 4. Transfer characteristics

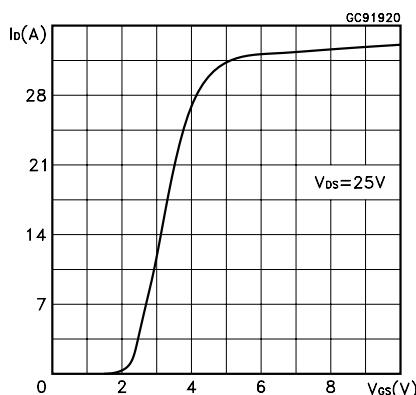


Figure 5. Normalized $V_{(BR)DSS}$ vs temperature

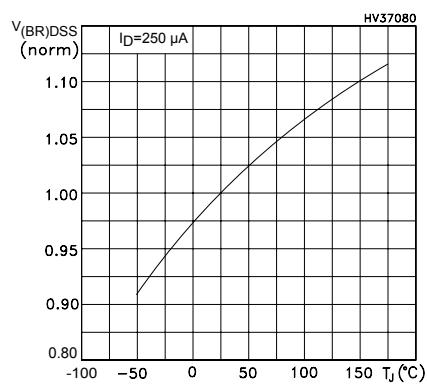


Figure 6. Static drain-source on-resistance

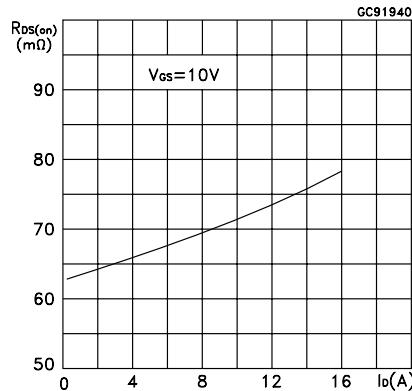
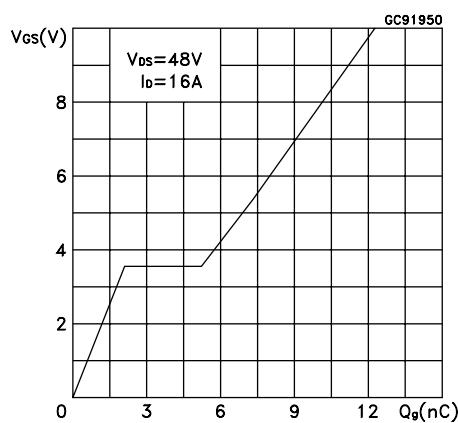
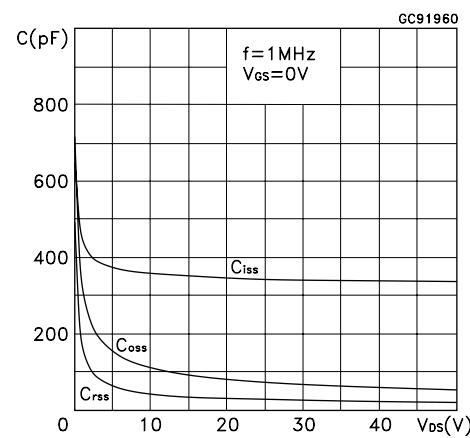
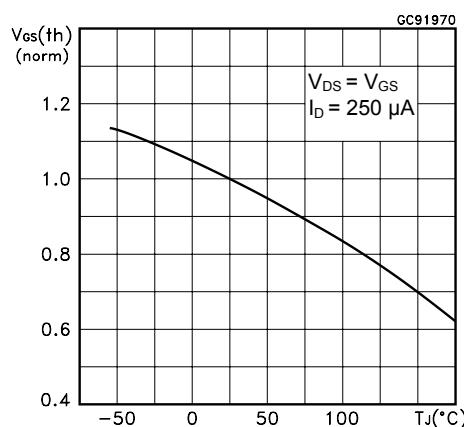
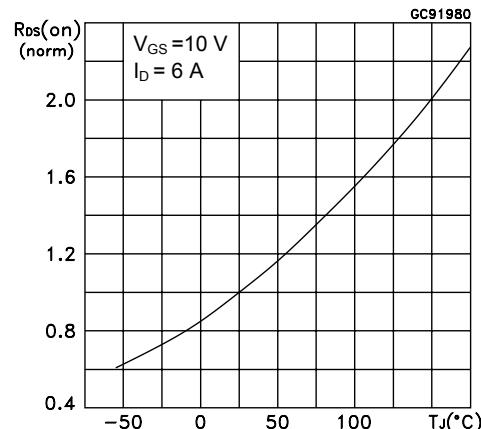
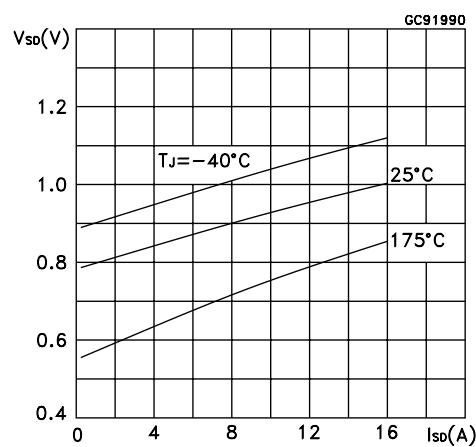
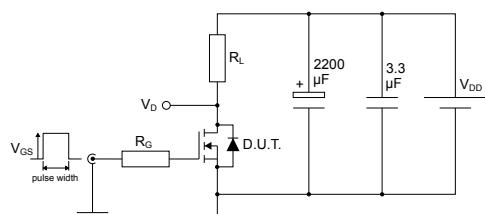


Figure 7. Gate charge vs gate-source voltage

Figure 8. Capacitance variations

Figure 9. Normalized gate threshold vs temperature

Figure 10. Normalized on-resistance vs temperature

Figure 11. Source-drain diode forward characteristics


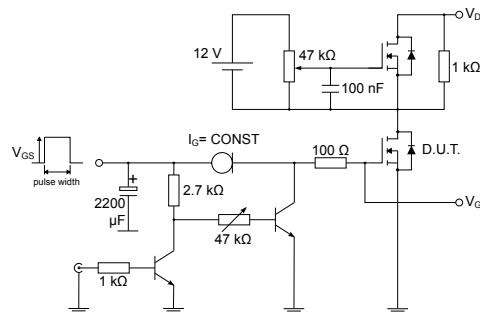
3 Test circuits

Figure 12. Test circuit for resistive load switching times



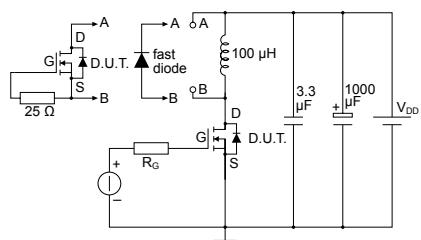
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Figure 13. Test circuit for gate charge behavior



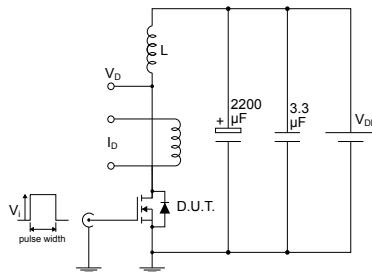
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Figure 14. Test circuit for inductive load switching and diode recovery times



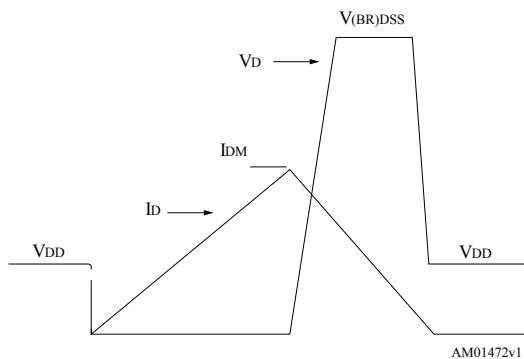
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Figure 15. Unclamped inductive load test circuit



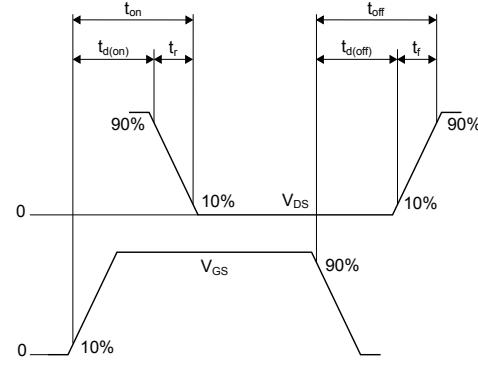
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Figure 16. Unclamped inductive waveform



AM01472v1

Figure 17. Switching time waveform



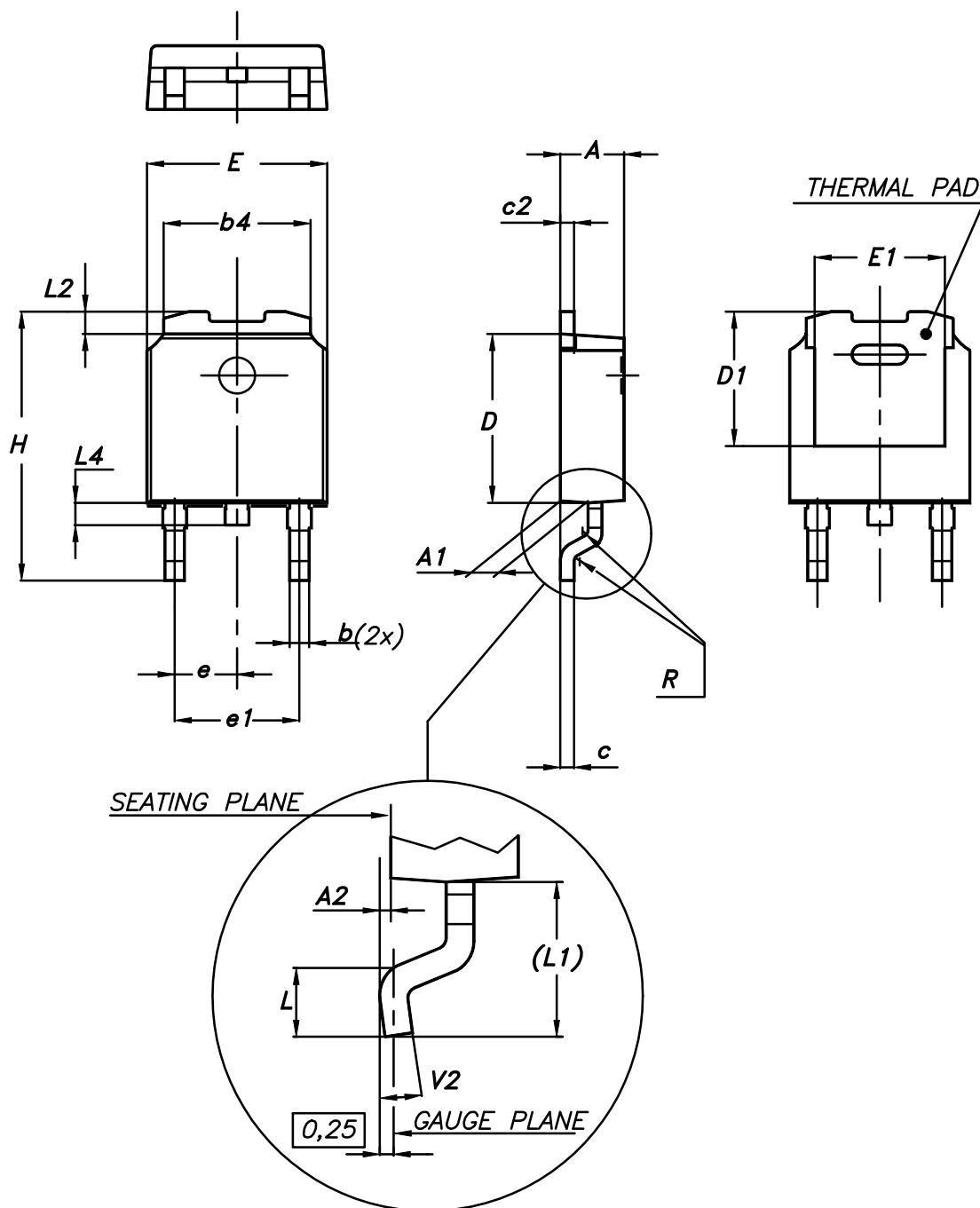
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4**Package information**

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 DPAK (TO-252) type A package information

Figure 18. DPAK (TO-252) type A package outline



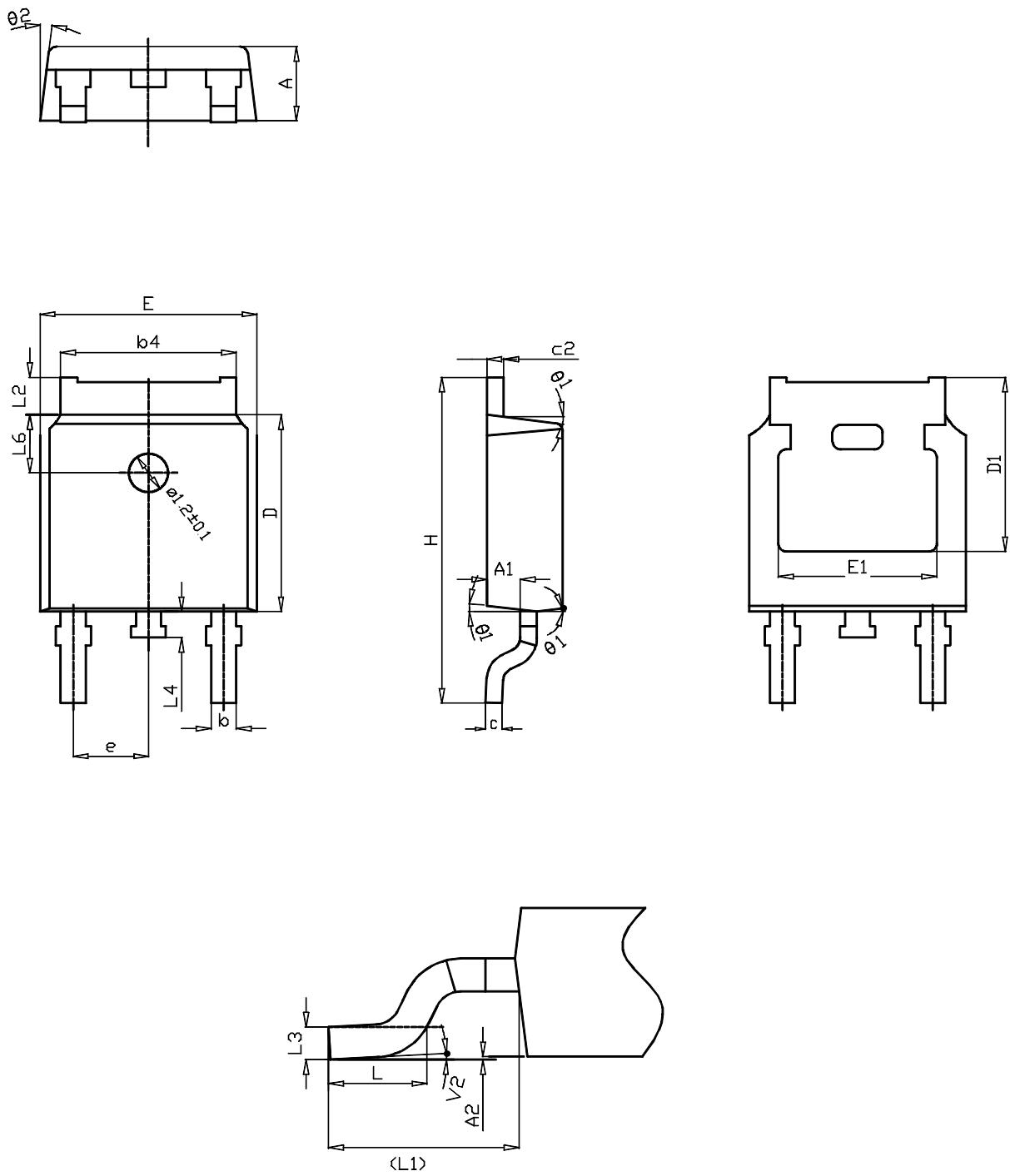
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Table 7. DPAK (TO-252) type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	4.60	4.70	4.80
e	2.159	2.286	2.413
e1	4.445	4.572	4.699
H	9.35		10.10
L	1.00		1.50
(L1)	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

4.2 DPAK (TO-252) type C package information

Figure 19. DPAK (TO-252) type C package outline



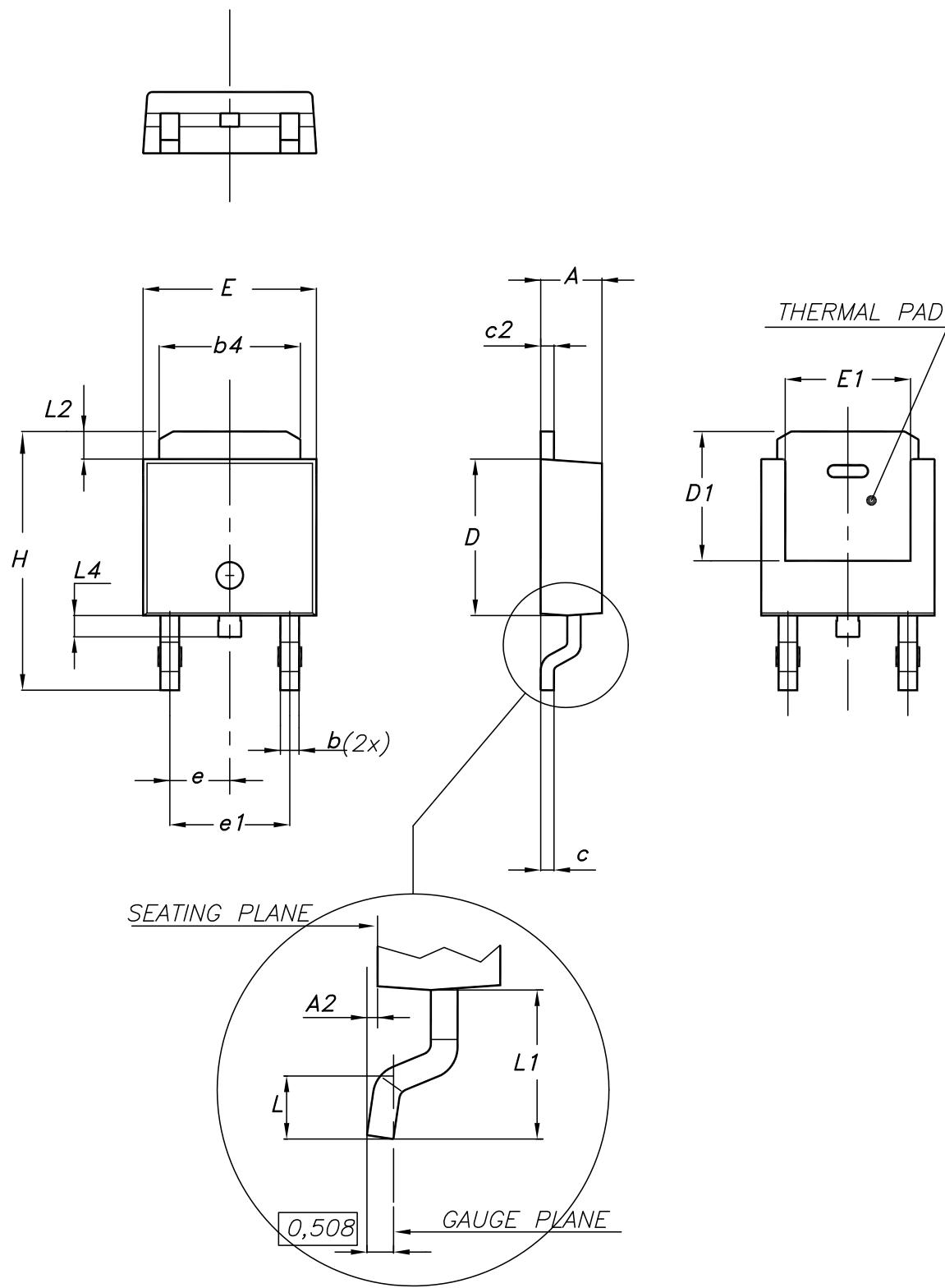
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Table 8. DPAK (TO-252) type C mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	2.20	2.30	2.38
A1	0.90	1.01	1.10
A2	0.00		0.10
b	0.72		0.85
b4	5.13	5.33	5.46
c	0.47		0.60
c2	0.47		0.60
D	6.00	6.10	6.20
D1	5.25		
E	6.50	6.60	6.70
E1	4.70		
e	2.186	2.286	2.386
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90 REF		
L2	0.90		1.25
L3	0.51 BSC		
L4	0.60	0.80	1.00
L6	1.80 BSC		
θ1	5°	7°	9°
θ2	5°	7°	9°
V2	0°		8°

4.3 DPAK (TO-252) type E package information

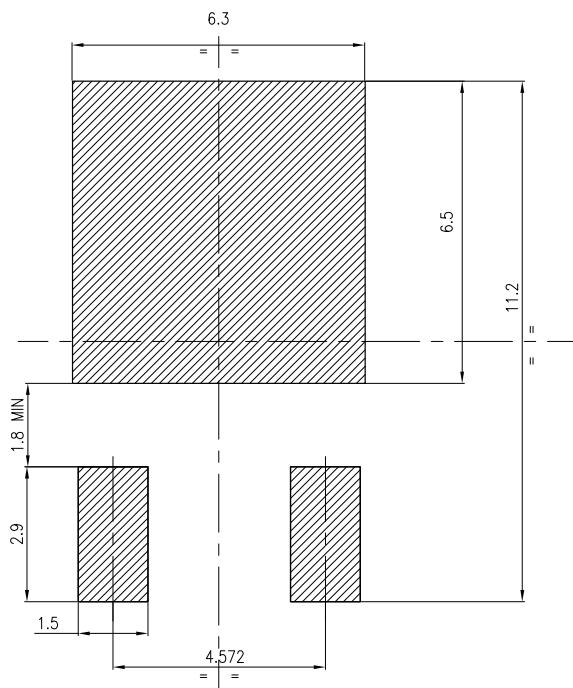
Figure 20. DPAK (TO-252) type E package outline



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Table 9. DPAK (TO-252) type E mechanical data

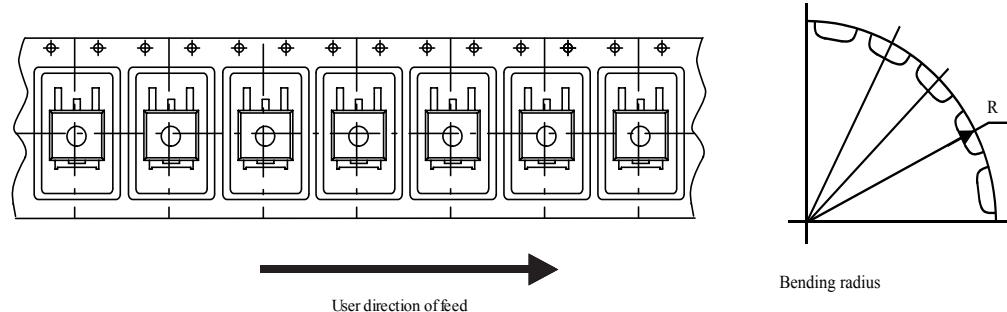
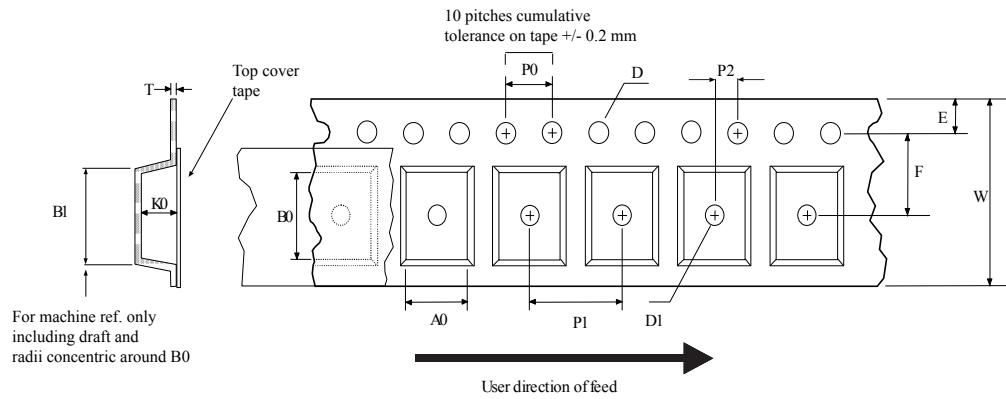
Dim.	mm		
	Min.	Typ.	Max.
A	2.18		2.39
A2			0.13
b	0.65		0.884
b4	4.95		5.46
c	0.46		0.61
c2	0.46		0.60
D	5.97		6.22
D1	5.21		
E	6.35		6.73
E1	4.32		
e		2.286	
e1		4.572	
H	9.94		10.34
L	1.50		1.78
L1		2.74	
L2	0.89		1.27
L4			1.02

Figure 21. DPAK (TO-252) recommended footprint (dimensions are in mm)

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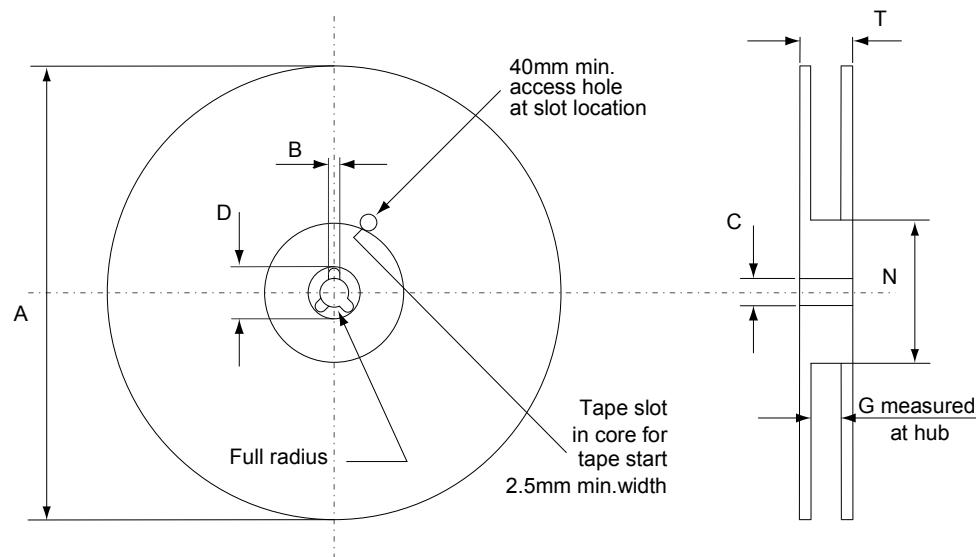
4.4 DPAK (TO-252) packing information

Figure 22. DPAK (TO-252) tape outline



Bending radius

AM08852v1

Figure 23. DPAK (TO-252) reel outline

AM06038v1

Table 10. DPAK (TO-252) tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	B	1.5	
B1		12.1	C	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	T		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base qty.		2500
P1	7.9	8.1	Bulk qty.		2500
P2	1.9	2.1			
R	40				
T	0.25	0.35			
W	15.7	16.3			

Revision history

Table 11. Document revision history

Date	Version	Changes
26-Jun-2014	1	First release.
14-Nov-2014	2	Updated title and features in cover page Updated <i>Table 3: Thermal data</i> , <i>Table 4: On/off states</i> and <i>Table 5:Dynamic</i> . Updated <i>Figure 2: Safe operating area</i> , <i>Figure 3: Thermal impedance</i> , <i>Figure 6: Normalized V(BR)DSS vs. temperature</i> , <i>Figure 10</i> , <i>Figure 11: Normalized on-resistance vs. temperature</i> and <i>Section 4: Package mechanical data</i> .
09-Aug-2018	3	Removed maturity status indication from cover page. The document status is production data. Updated title and features on cover page. Updated Section 4 Package information . Minor text changes

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